

Industrial imaging

# **3D volume control** for segmented containers



## **3D** sensors



Reduced waste and downtime

Independent of soiling, colour and coating

Intuitive teaching and selection of different shapes, sets and formats

Easy step-by-step parameter setting

Empty state and overfill can be detected separately

Quality control independent of extraneous light



## Advantages of 3D volume control

The system is used to check the homogeneous filling of containers with viscous media, such as dough or pastes. An example is the detection of double dough. Automated bread production is prone to errors during the simultaneous filling of several baking tins (tin sets). Tins that remain unfilled compromise efficiency. Overfilled tins on the other hand lead to reduced quality and increased soiling of the installation and may even elevate the risk of fire.

#### Versatile use

The application is an optimum choice for many different manufacturing processes. It can be used in food processing (production of bread, cheese, pasta and meat products), but also for the manufacture of consumer goods based on rubber, creams or waxes. The 3D volume control helps to reduce waste and downtime and to save costs.



Type of sensor	Material front pane / LED window	Protection rating / protection class	Angle of aperture [°]	Max. field of view size [m]	Order no.		
PMD 3D sensors · Type O3D · M12 connector · Housing material: Aluminium							
PMD 3D ToF chip	Gorilla glass / polyamide	IP 65, IP 67 / III	40 x 30	2.61 x 3.47	O3D300		
PMD 3D ToF chip	Gorilla glass / polyamide	IP 65, IP 67 / III	60 x 45	3.75 x 5.00	O3D302		
PMD 3D ToF chip	Gorilla glass / polyamide	IP 65, IP 67 / III	70 x 51	4.00 x 5.50	O3D304		
PMD 3D sensors · Type O3D · M12 connector · Housing material: Stainless steel							
PMD 3D ToF chip	PMMA / polyamide	IP 65, IP 67, IP 69K / III	40 x 30	2.61 x 3.47	O3D310		
PMD 3D ToF chip	PMMA / polyamide	IP 65, IP 67, IP 69K / III	60 x 45	3.75 x 5.00	O3D312		
PMD 3D ToF chip	PMMA / polyamide	IP 65, IP 67, IP 69K / III	70 x 51	4.00 x 5.50	O3D314		

Technical data volume control							
Operating distance	[m]	0.35					
Max. handling unit size		64 objects					
Minimum size of objects Object speed: 00.2 m/s Object speed: > 0.2 m/s	[mm]	25 45					
Sampling rate / switching frequency The image repetition frequency reduced by using the position tra function	[Hz] is acking	10					

## Further technical data

Operating voltage	[V DC]	20.428.8
Current consumption	[mA]	< 2400 peak current pulsed; typ. mean value 420
Current rating (per switching output)	[mA]	100
Short-circuit protection, pulsed		•
Overload protection		•
Ambient temperature	[°C]	-1050
Real chip resolution		25,000 / 100,000
Resulting resolution		176 x 132 pixels
Function display	LED	2 x yellow, 2 x green
Illumination		850 nm, infrared
Immunity to extraneous light	[klx]	8 (up to 100 klx possible with reduced measuring accuracy and repeatability)
Trigger		external; 24 V PNP/NPN according to IEC 61131-2 type 3
Switching inputs		2 (configurable), 24 V PNP/NPN according to IEC 61131-2 type 3
Switching outputs digital		3 (configurable), 24 V PNP/NPN, according to IEC 61131-2
Switching outputs analogue		1 (can be configured as current output 420 mA or voltage output 010 V)
Parameter setting interface Ethernet		10 Base-T /100 Base-TX
Parameter setting options		via PC / notebook
Dimensions (H, W, D)	[mm]	72 x 67.1 x 95

## Accessories

	Design	Description	Order no.			
	Mounting accessories					
	1100	Mounting set for O3D	E3D301			
		Dissipators	E3D302			
		Double cooling element	E3D304			
	<i>×Cm</i>	Heat conductor	E3D303			
	Connection technology					
.2018		Ethernet, cross-over patch cable, 2 m, PVC cable, M12 / RJ45	E11898			
ce 11.						
prior noti		Ethernet, jumper cable, 2 m, PVC cable, M12 / M12	E21138			
without						
Iterations		Socket, M12, 2 m black, PUR cable, 8-pole	E11950			
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